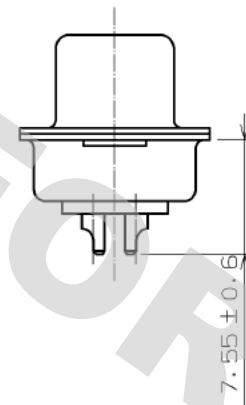
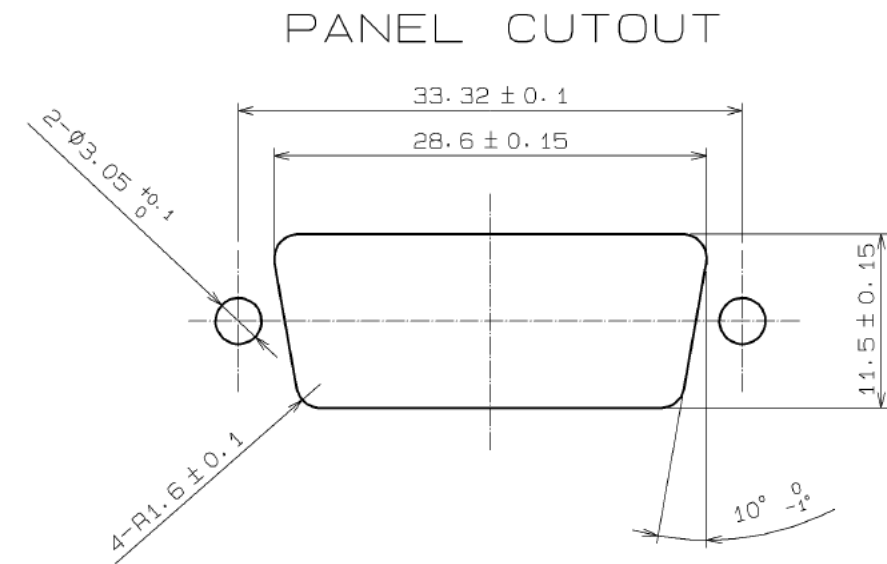
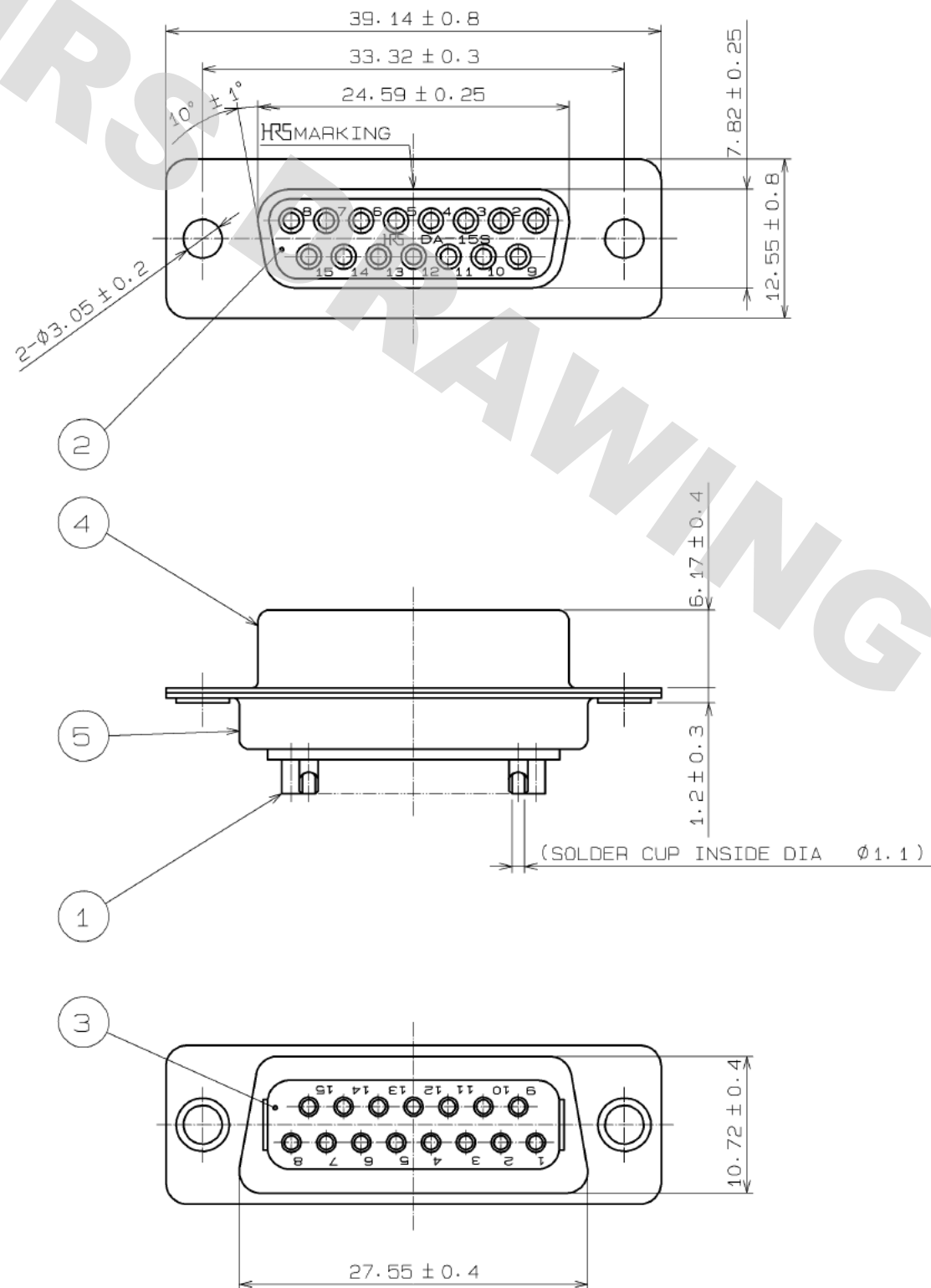


DRAWING F
05/31/2013



NOTE 1. SOLDERING SHALL BE DONE WITH SOLDERING BIT
OF 40W MAX WITHIN 4 SEC.

2 CONTACT AREA :GOLD PLATING 0.5 μ m MIN
TERMINAL AREA:GOLD PLATING 0.03 μ m MIN
UNDER PLATING:NICKEL PLATING 1.27 μ m MIN

3	PBT	BLACK, UL94V-0	5	STEEL	OVER PLATING : NICKEL 1μm min. UNDER PLATING : COPPER 5μm min.				
2	PBT	BLACK, UL94V-0	4	STEEL	OVER PLATING : NICKEL 1μm min. UNDER PLATING : COPPER 5μm min.				
1	PHOSPHOR BRONZE	2							
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : RI. TAKAYASU	13.01.31	DRAWING NO.		EDC3-009504-01			
		CHECKED : EJ. WAKATSUKI	13.01.31	PART NO.		HDAB-15S(57)			
		DESIGNED : TS. ITO	13.01.31	CODE NO.		CL211-0235-4-57			
		DRAWN : TY. ITO	13.01.31						